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## H7N0405LD, H7N0405LS, H7N0405LM

# Silicon N Channel MOS FET High Speed Power Switching

REJ03G1367-0100 Rev.1.00 Sep 25, 2006

#### **Features**

- Low on-resistance  $R_{DS(on)} = 4.0 \text{ m}\Omega \text{ typ.}$
- Low drive current.
- Capable of 4.5 V gate drive

#### **Outline**

RENESAS Package code: PRSS0004AE-A (Package name: LDPAK (L) )



H7N0405LD

RENESAS Package code: PRSS0004AE-B (Package name: LDPAK (S)-(1) )



H7N0405LS

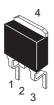
1. Gate

2. Drain

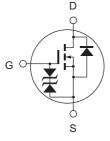
3. Source

4. Drain

RENESAS Package code: PRSS0004AE-C (Package name: LDPAK (S)-(2) )



H7N0405LM



#### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Rating	Unit
Drain to source voltage	V <sub>DSS</sub>	40	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	$I_D$	80	А
Drain peak current	I <sub>D</sub> (pulse) <sup>Note1</sup>	320	А
Body drain diode reverse drain current	$I_{DR}$	80	А
Avalanche current	I <sub>AP</sub> Note3	40	А
Avalanche energy	E <sub>AR</sub> Note3	213	mJ
Channel dissipation	Pch <sup>Note2</sup>	80	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Tc = 25°C

3. Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

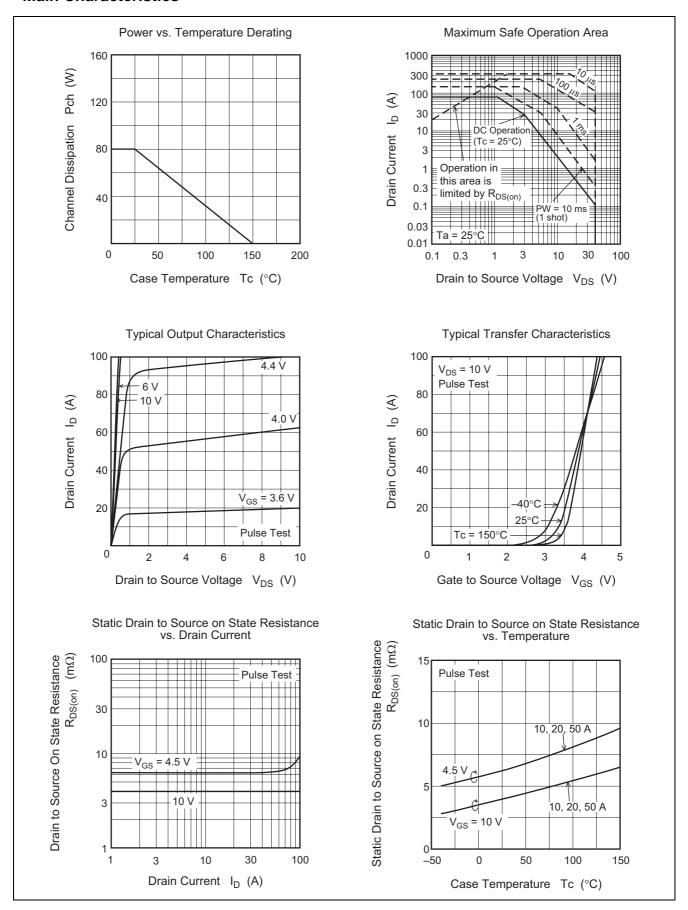
#### **Electrical Characteristics**

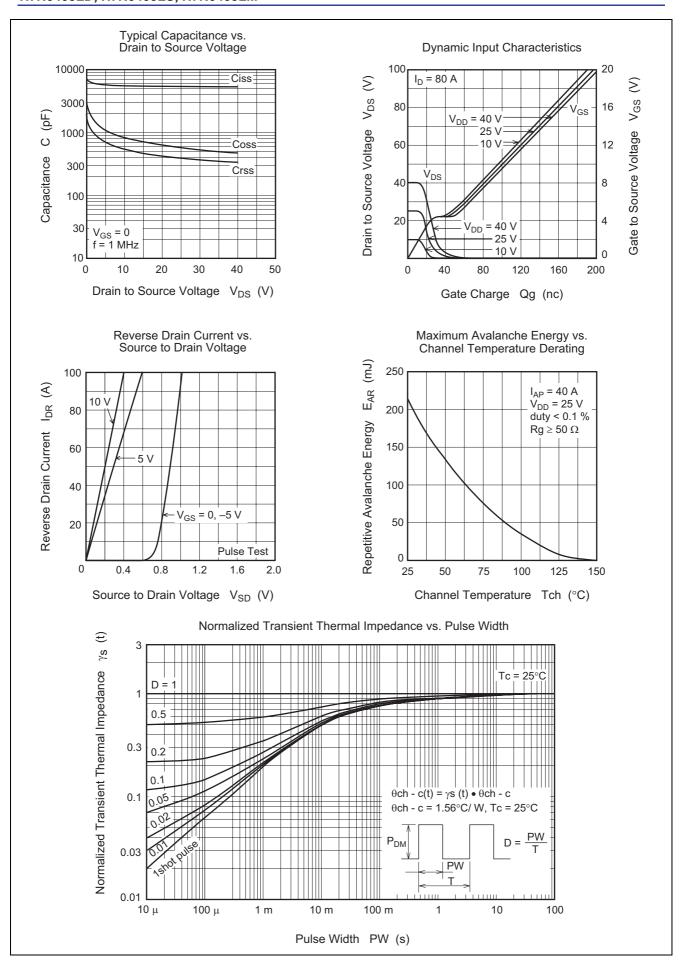
 $(Ta = 25^{\circ}C)$ 

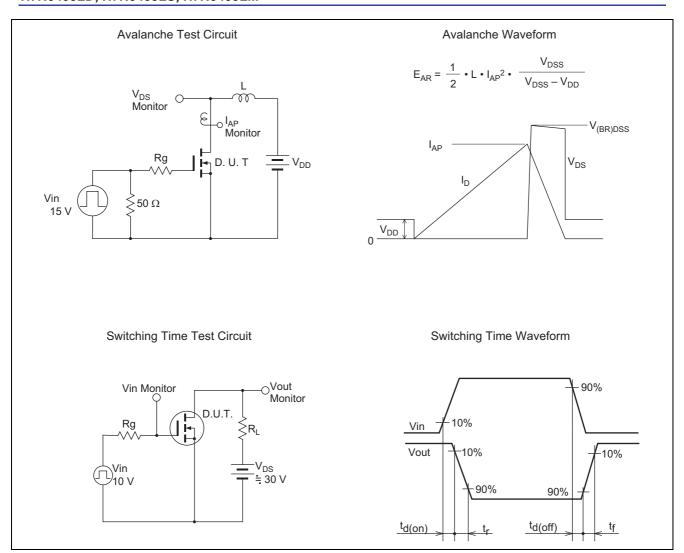
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source break down voltage	$V_{(BR)DSS}$	40	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	$I_{GSS}$		_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$		_	10	μΑ	$V_{DS} = 40 \text{ V}, V_{GS} = 0$
Gate to source cut off voltage	$V_{GS(off)}$	1.5	_	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Static drain to source on state	R <sub>DS(on)</sub>	_	4.0	5.0	mΩ	$I_D = 40 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance		_	6.2	8.7	mΩ	$I_D = 40 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y <sub>fs</sub>	54	90	_	S	$I_D = 40 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	5600	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	825	_	pF	f = 1 MHz
Reverse transfer admittance	Crss	_	550	_	pF	]
Total gate charge	Qg	_	100	_	nC	$V_{DD} = 25 \text{ V}, V_{GS} = 10 \text{ V},$
Gate to source charge	Qgs	_	25	_	nC	$I_D = 80 \text{ A}$
Gate to drain charge	Qgd	_	25	_	nC	]
Turn-off delay time	t <sub>d(on)</sub>	_	40	_	ns	$V_{GS} = 10 \text{ V}, I_D = 40 \text{ A},$
Rise time	t <sub>r</sub>	_	400	_	ns	$R_L = 0.75 \Omega$ , $Rg = 4.7 \Omega$
Body-drain diode forward voltage	t <sub>d(off)</sub>	_	100	_	ns	
Fall time	t <sub>f</sub>	_	26	_	ns	]
Body-drain diode forward voltage	$V_{DF}$	_	0.94	_	V	$I_F = 80 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery	t <sub>rr</sub>	_	40	_	ns	$I_F = 80 \text{ A}, V_{GS} = 0$
time						$di_F/dt = 100 A/\mu s$

Notes: 4. Pulse test

#### **Main Characteristics**





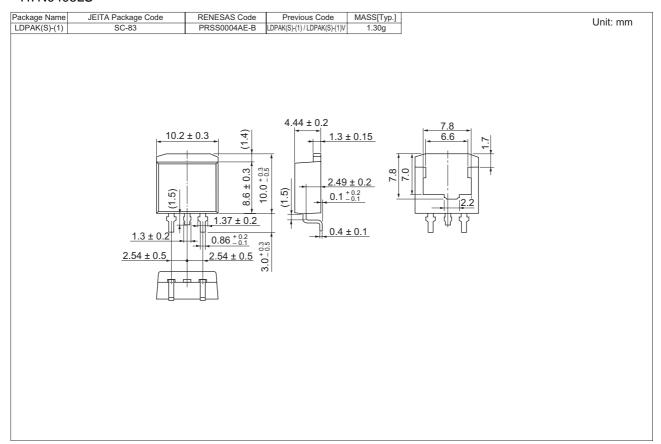


#### **Package Dimensions**

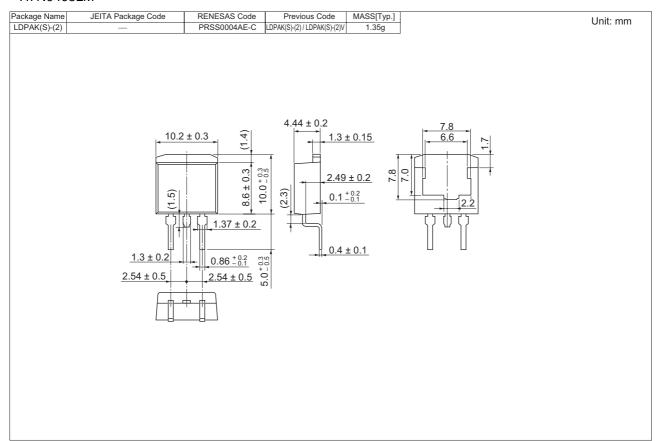
#### • H7N0405LD

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	Unit: mm
LDPAK(L)	_	PRSS0004AE-A	LDPAK(L) / LDPAK(L)V	1.40g	] Onit: mm
		11.3 ± 0.5 10.0 ± 0.5 10.0 ± 0.5 8.6 ± 0.05 2.54 ± 0.5	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	11.0 ± 0.5	$ \begin{array}{c} 4.44 \pm 0.2 \\ 1.3 \pm 0.15 \end{array} $ $ 2.49 \pm 0.2 $ $ 0.4 \pm 0.1 $

#### • H7N0405LS



#### • H7N0405LM



#### **Ordering Information**

Part Name	Quantity	Shipping Container
H7N0405LD-E	500 pcs	Box (Conductive Sack)
H7N0405LSTL-E	1000 pcs	Taping
H7N0405LMTL-E	1000 pcs	Taping

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